

75mΩ, 650V, Super Junction N-Channel Power MOSFET
SRC65R075BS

General Description

The Sanrise SRC65R075BS is a high voltage power MOSFET, fabricated using advanced super junction technology. The resulting device has extremely low on resistance, low gate charge and fast switching time, making it especially suitable for applications which require superior power density and outstanding efficiency.

The SRC65R075BS break down voltage is 650V and it has a high rugged avalanche characteristics.

The SRC65R075BS is available in TO-263-2 , TO-220F, TO-220C and TO-247 packages.

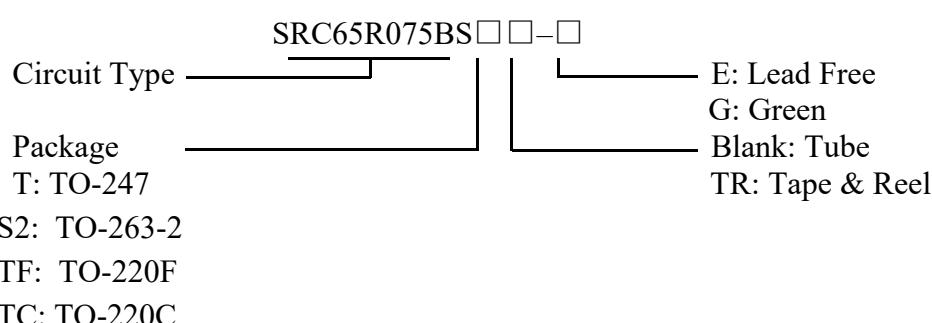
Features

- Ultra Low $R_{DS(ON)}$ = 75mΩ @ V_{GS} = 10V.
- $V_{ds} @ T_{jmax} = 700V$
- Ultra Low Gate Charge, $Q_g = 133nC$ typ.
- Fast switching capability
- Robust design with better EAS performance
- EMI Improved
- Non-automotive Qualified
- Ultra-fast body diode

Application

- Telecom Power
- EV Charger

Ordering Information



Package	Part Number	Marking ID	Packing Type
TO-247	SRC65R075BST-G	SRC65R075BSTG	Tube
TO-220F	SRC65R075BSTF-G	SRC65R075BSTFG	Tube
TO-263-2	SRC65R075BSS2TR-G	SRC65R075BSS2G	Tape & Reel
TO-220C	SRC65R075BSTC-G	SRC65R075BSTCG	Tube

Symbol

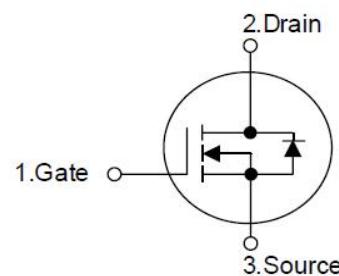


Figure 1 Symbol of SRC65R075BS

Package Type

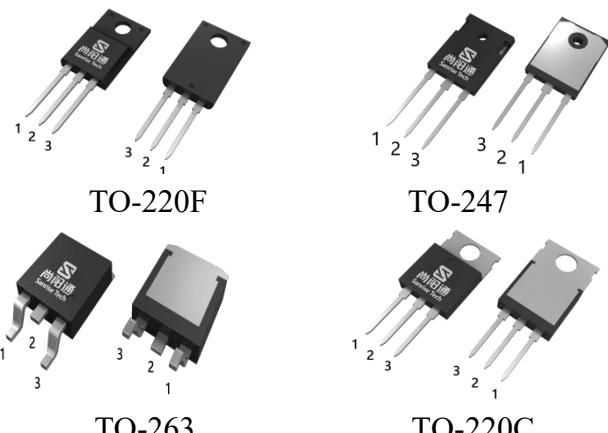


Figure 2 Package Types of SRC65R075BS

Absolute Maximum Ratings^{Note 1}

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DSS}	650	V
Gate-Source Voltage (static)	V _{GSS}	±20	V
Gate-Source Voltage (dynamic), AC (f>1 Hz)	V _{GSS}	±30	V
Continuous Drain Current	T _C =25°C	44	A
	T _C =100°C	27	
	T _C =125°C	19	
Power Dissipation (T _c =25°C, TO-220F)	P _{tot}	34	W
Power Dissipation (T _c =25°C, TO-247, TO-220C, TO-263)	P _{tot}	328	W
Pulsed Drain Current (Note 2)	I _{DM}	132	A
Avalanche Energy, Single Pulse (Note 3)	E _{AS}	320	mJ
Avalanche Energy, Single Pulse (Note 4)	E _{AS}	1500	mJ
Avalanche Energy, Repetitive (Note 2)	E _{AR}	0.2	mJ
Avalanche Current, Repetitive (Note 2)	I _{AR}	4.0	A
Continuous Diode Forward Current	I _S	44	A
Diode Pulse Current	I _{S,PULSE}	132	A
MOSFET dv/dt Ruggedness, V _{DS} <=480V	dv/dt	120	V/ns
Reverse Diode dv/dt, V _{DS} <=480V, I _{SD} <=I _D	dv/dt	50	V/ns
Operating Junction Temperature	T _J	150	°C
Storage Temperature	T _{STG}	-55 to 150	°C
Lead Temperature (Soldering, 10 sec)	T _{LEAD}	260	°C

Note:

1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.
Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature
3. I_{AS}=4.0A, V_{DD}=60V, R_G=25Ω, Starting T_J=25°C.Finish goods test condition
- 4.I_{AS}=8.7A, V_{DD}=60V, R_G=25Ω, Starting T_J=25°C.Typical Eas

Thermal characteristics

Parameter	Symbol	Min	Typ	Max	Unit
Thermal resistance, Junction-to-Case	TO-220F			3.6	°C /W
	TO-220C			0.38	
	TO-247			0.38	
	TO-263			0.38	
Thermal resistance, Junction-to-Ambient	TO-220F			70	°C /W
	TO-220C			59	
	TO-247			59	
	TO-263			59	

Electrical Characteristics

T_J = 25 °C, unless otherwise specified.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	650			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V			10	uA
Gate-Body Leakage Current	Forward	I _{GSSF}	V _{GS} =20V, V _{DS} =0V		100	nA
	Reverse	I _{GSSR}	V _{GS} =-20V, V _{DS} =0V		-100	
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =1.0mA	3.5	4.5	5.5	V
Static Drain-Source On-Resistance	R _{DSS(ON)}	V _{GS} =10V, I _D =24A		60	75	mΩ
Gate Resistance	R _G	f=1MHz, Open Drain		2.0		Ω
Dynamic Characteristics						
Input Capacitance	C _{ISS}	V _{DS} =400V, V _{GS} =0V, f=100kHz		2792		pF
Output Capacitance	C _{OSS}			78		pF
Effective output capacitance, energy related <small>NOTE5</small>	C _{O(er)}	V _{GS} =0V, V _{DS} =0...480V		110		pF
Effective output capacitance, time related <small>NOTE6</small>	C _{O(tr)}			751		
Turn-on Delay Time	t _{d(on)}	V _{DD} =400V, I _D =24A R _G =3Ω, V _{GS} =12V		50		ns
Rise Time	t _r			16		
Turn-off Delay Time	t _{d(off)}			69		
Fall Time	t _f			10		
Gate Charge Characteristics						
Gate to Source Charge	Q _{gs}	V _{DD} =480V, I _D =24A V _{GS} =0 to 10V		24		nC
Gate to Drain Charge	Q _{gd}			85		
Gate Charge Total	Q _g			133		
Gate Plateau Voltage	V _{plateau}			7.0		
Reverse Diode Characteristics						
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _{SD} =24A		0.86	1.1	V
Reverse Recovery Time	t _{rr}	V _R =400V, I _F =24A dI _F /dt=120A/us		190		ns
Reverse Recovery Charge	Q _{rr}			1.9		uC
Peak Reverse Recovery Current	I _{rrm}			18		A

Note:

5. C_{O(er)} is a fixed capacitance that gives the same stored energy as C_{OSS} while V_{DS} is rising from 0 to 480V

6. C_{O(tr)} is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising from 0 to 480 V



Sanrise Tech

尚阳通

Shenzhen Sanrise Technology Co., LTD

<http://www.sanrise-tech.com>

IMPORTANT NOTICE

Shenzhen Sanrise Technology Co., LTD. reserves the right to make changes without further notice to any products or specifications herein. Shenzhen Sanrise Technology Co., LTD. does not assume any responsibility for use of any its products for any particular purpose, nor does Shenzhen Sanrise Technology Co., LTD. assume any liability arising out of the application or use of any its products or circuits. Shenzhen Sanrise Technology Co., LTD. does not convey any license under its patent rights or other rights nor the rights of others.

Main Site:

- Headquarter

Shenzhen Sanrise Technology Co., LTD.

A1206, Skyworth building, No. 008, gaoxinnan 1st Road,
Gaoxin District, Yuehai street,, Nanshan District, ShenZhen,
P.R.China

Tel: +86-755-22953335

Fax: +86-755-22916878

- Shanghai Office

Shenzhen Sanrise Technology Co., LTD

Rm.401, Building B, No. 666, Zhangheng Road,
Zhangjiang Hi-Tech Park, Shanghai, P.R.China

Tel: +86-21-68825918